

NP60N06PDK

60 V – 60 A – N-channel Power MOS FET

R07DS1296EJ0200 May 24, 2018

Application: Automotive

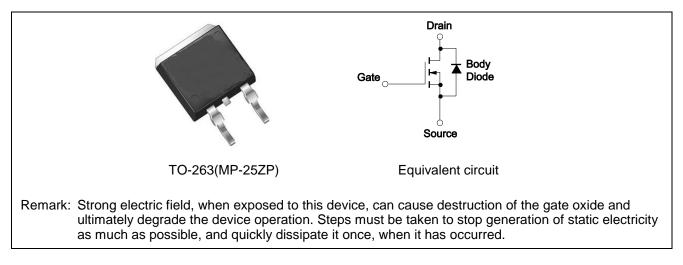
Description

NP60N06PDK is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

- Super low on-state resistance
- ---- $R_{DS(on)1} = 7.9 \text{ m}\Omega \text{ MAX}$. ($V_{GS} = 10 \text{ V}$, $I_D = 30 \text{ A}$)
- Low C_{iss} : $C_{iss} = 2400 \text{ pF TYP}$. ($V_{DS} = 25 \text{ V}$)
- Designed for automotive application and AEC-Q101 qualified

Outline



Ordering Information

| Part No. | Lead Plating | Pac | Package | | |
|---------------------|---------------|-----------------|------------------|------------------|--|
| NP60N06PDK-E1-AY *1 | Pure Sn (Tin) | Topo 900 p/rool | Taping (E1 type) | TO-263(MP-25ZP) | |
| NP60N06PDK-E2-AY *1 | | Tape 800 p/reel | Taping (E2 type) | 10-203(IMF-252F) | |

Note: *1. Pb-free (This product does not contain Pb in the external electrode)

RENESAS

Rev.2.00

Absolute Maximum Ratings (T_A = 25°C)

| Item | Symbol | Ratings | Unit |
|---|-----------------------|-------------|------|
| Drain to Source Voltage ($V_{GS} = 0 V$) | V _{DSS} | 60 | V |
| Gate to Source Voltage (V _{DS} = 0 V) | V _{GSS} | ±20 | V |
| Drain Current (DC) ($T_c = 25^{\circ}C$) | I _{D(DC)} | ±60 | A |
| Drain Current (pulse) *1*3 | I _{D(pulse)} | ±240 | A |
| Total Power Dissipation ($T_C = 25^{\circ}C$) | P _{T1} | 105 | W |
| Total Power Dissipation ($T_A = 25^{\circ}C$) | P _{T2} | 1.8 | W |
| Channel Temperature | T _{ch} | 175 | °C |
| Storage Temperature | T _{stg} | -55 to +175 | °C |
| Repetitive Avalanche Current *2*3 | I _{AR} | 25 | A |
| Repetitive Avalanche Energy *2*3 | E _{AR} | 63 | mJ |

Thermal Resistance

| Channel to Case Thermal Resistance | $R_{th(ch-C)}$ *3 | 1.43 | °C/W |
|---------------------------------------|-------------------|------|------|
| Channel to Ambient Thermal Resistance | $R_{th(ch-A)}$ *3 | 83.3 | °C/W |

Notes: *1. T_C = 25°C, PW \leq 10 $\mu s,$ Duty Cycle \leq 1%

*2. R_G = 25
$$\Omega$$
, V_{GS} = 20 V \rightarrow 0 V

*3. Not subject of production test. Verified by design/characterization.



| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|----------------------------------|----------------------|-----|------|------|------|--|
| Zero Gate Voltage Drain Current | I _{DSS} | | | 1 | μΑ | $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ |
| Gate Leakage Current | I _{GSS} | | | ±100 | nA | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ |
| Gate to Source Threshold Voltage | V _{GS(th)} | 1.5 | 2.1 | 2.5 | V | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ |
| Forward Transfer Admittance *1 | y _{fs} | 30 | 54 | | S | $V_{DS} = 5 V, I_D = 30 A$ |
| Drain to Source On-state | R _{DS(on)1} | | 6.4 | 7.9 | mΩ | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$ |
| Resistance *1 | R _{DS(on)2} | | 7.0 | 12.0 | mΩ | $V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$ |
| Input Capacitance *2 | Ciss | | 2400 | 3600 | pF | $V_{DS} = 25 V,$ |
| Output Capacitance *2 | Coss | | 230 | 350 | pF | $V_{GS} = 0 V,$ |
| Reverse Transfer Capacitance *2 | C _{rss} | | 80 | 150 | pF | f = 1 MHz |
| Turn-on Delay Time *2 | t _{d(on)} | | 18 | 40 | ns | $V_{DD} = 30 \text{ V}, \text{ I}_{D} = 30 \text{ A},$ |
| Rise Time *2 | tr | | 6 | 20 | ns | Vgs = 10 V, |
| Turn-off Delay Time *2 | t _{d(off)} | | 45 | 90 | ns | R _G = 0 Ω |
| Fall Time *2 | tr | | 3 | 10 | ns | _ |
| Total Gate Charge *2 | Q _G | | 37 | 56 | nC | $V_{DD} = 48 V,$ |
| Gate to Source Charge | Q _{GS} | | 9 | | nC | V _{GS} = 10 V, |
| Gate to Drain Charge | Q _{GD} | | 8 | | nC | I _D = 60 A |
| Body Diode Forward Voltage *1 | VF(S-D) | | 0.9 | 1.5 | V | I _F = 60 A, V _{GS} = 0 V |
| Reverse Recovery Time | t _{rr} | | 32 | | ns | $I_F = 60 \text{ A}, V_{GS} = 0 \text{ V},$ |
| Reverse Recovery Charge | Qrr | | 30 | | nC | di/dt = 100 A/µs |

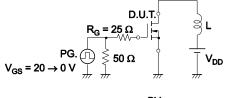
Electrical Characteristics (T_A = 25°C)

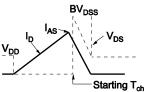
Note: *1. Pulsed test

Note: *2. Not subject of production test. Verified by design/characterization.

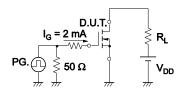
TEST CIRCUIT 1 AVALANCHE CAPABILITY

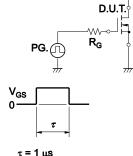
TEST CIRCUIT 2 SWITCHING TIME



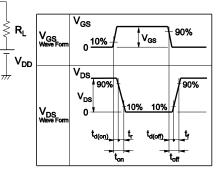


TEST CIRCUIT 3 GATE CHARGE



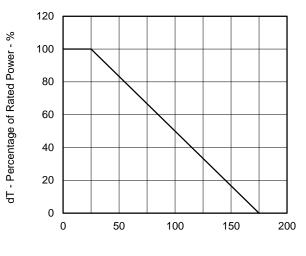






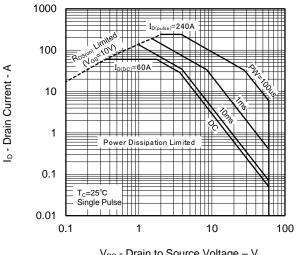
Typical Characteristics (T_A = 25°C)

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

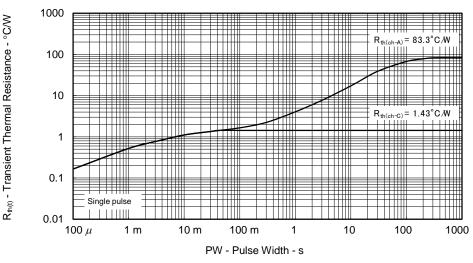


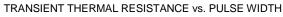
 T_{C} - Case Temperature - $^{\circ}C$





 V_{DS} - Drain to Source Voltage – V







TOTAL POWER DISSIPATION vs.

100

T_c - Case Temperature - °C

150

200

120

100

80

60

40

20

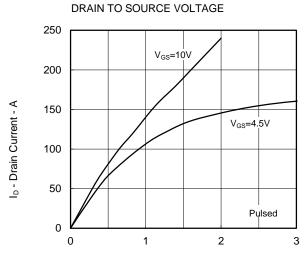
0

0

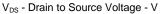
50

 $P_t - Total Power Dissipation - W$

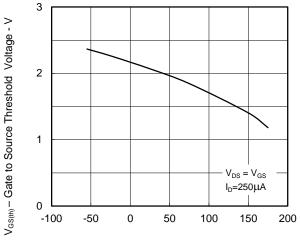
CASE TEMPERATURE



DRAIN CURRENT vs.

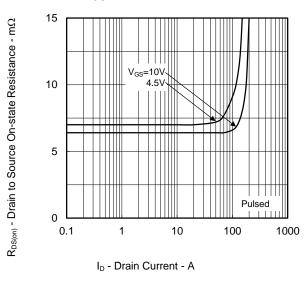


GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

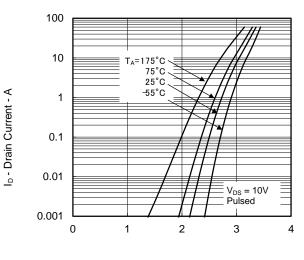


T_{ch} - Channel Temperature - °C

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

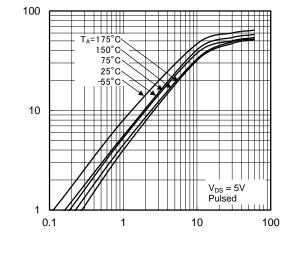


FORWARD TRANSFER CHARACTERISTICS

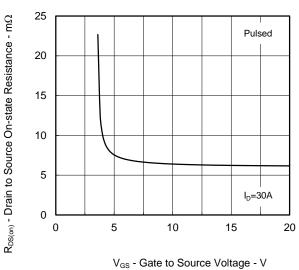


V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



I_D - Drain Current - A

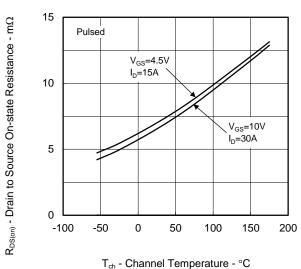


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

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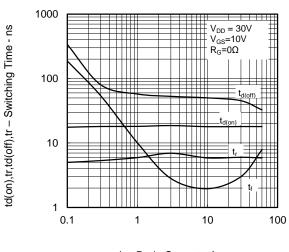


 $\mid y_{fs} \mid$ - Forward Transfer Admittance - S



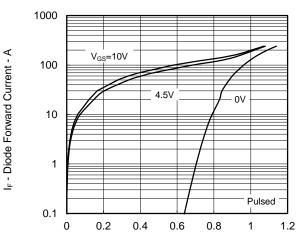
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE

SWITCHING CHARACTERISTICS



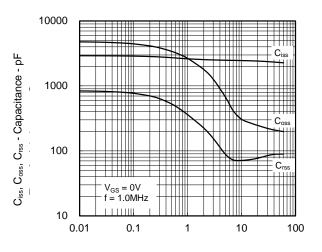
I_D - Drain Current - A

SOURCE TO DRAIN DIODE FORWARD VOLTAGE



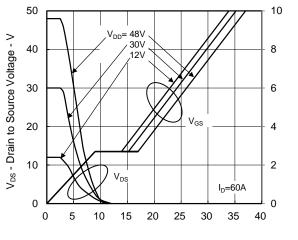
 $V_{\text{F(S-D)}}$ - Source to Drain Voltage - V

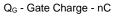
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



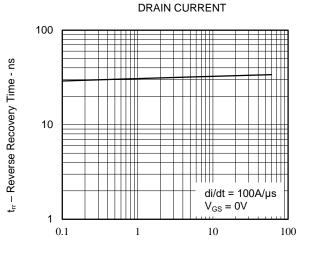








REVERSE RECOVERY TIME vs.

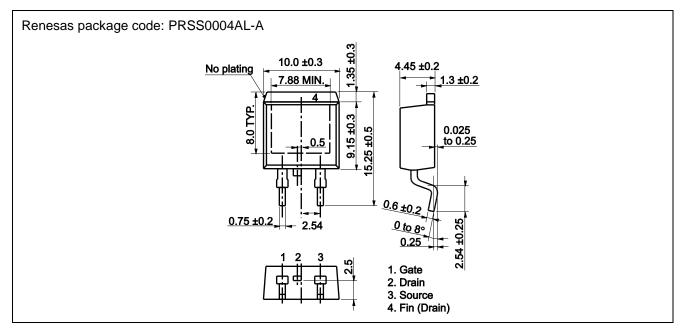


IF - Drain Current - A



Package Drawings (Unit: mm)

TO-263 (MP-25ZP) (Mass: 1.48 g TYP.)





Revision History

NP60N06PDK Data Sheet

| | | Description | | |
|------|---------------|-------------|--|--|
| Rev. | Date | Page | Summary | |
| 1.00 | Oct. 26, 2015 | — | First Edition Issued | |
| 1.01 | Dec. 21, 2015 | 2 | Modification of Repetitive Avalanche Energy(83mJ \rightarrow 63mJ) | |
| 2.00 | May 24 ,2018 | 2 | Note 3 was added | |
| | | 3 | Note 2 was added | |

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